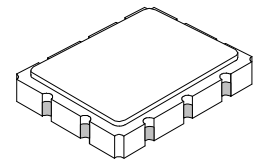


**SF1059A**

- **Designed for WLAN IF Applications**
- **Low Insertion Loss**
- **9.1 x 7.1 mm Version of SF1059A-1**
- **Unbalanced Input and Output**

**350.0 MHz
SAW Filter****SM9171-10****Absolute Maximum Ratings**

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Max Soldering Profile	265°C for 10 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_c	1	350.00			MHz
Passband Insertion Loss at f_c 3 dB Passband Amplitude Variation over $f_c \pm 250$ kHz Group Delay Variation over $f_c \pm 400$ kHz	IL	1, 2		8	10.0	dB
	BW_3		± 400	± 600		kHz
				0.5	1.0	dB _{p-p}
	GDV			200	250	ns _{p-p}
Rejection $f_c - 8.0$ to $f_c - 2.0$ and $f_c + 2.0$ to $+8.0$ MHz $f_c - 50$ to $f_c - 8.0$ and $f_c + 8.0$ to $f_c + 50$ MHz Ultimate		1, 2, 3	35	40		dB
			40	45		
				50		
Operating Temperature Range	T_A	1	-20		+70	°C

Impedance Matching to 50 Ω unbalanced	External L-C
Case Style	SM9171-10 9.1 x 7.1 mm Nominal Footprint
Lid Symbolization (XX = 2 character date code)	RFM SF1059A XX

Electrical Connections

Connection	Terminals
Port 1	Input or Return
	Return or Input
Port 2	Output or Return
	Return or Output
Ground	All others
Single Ended Operation	Return is ground
Differential Operation	Return is hot

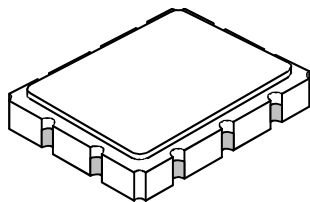
Notes:

1. Unless noted otherwise, all specification apply over the operating temperature range with filter soldered to the specified demonstration board with impedanced matching to 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f_c .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
9. Electrostatic Sensitive Device. Observe precautions for handling.



SM9171-10 Case

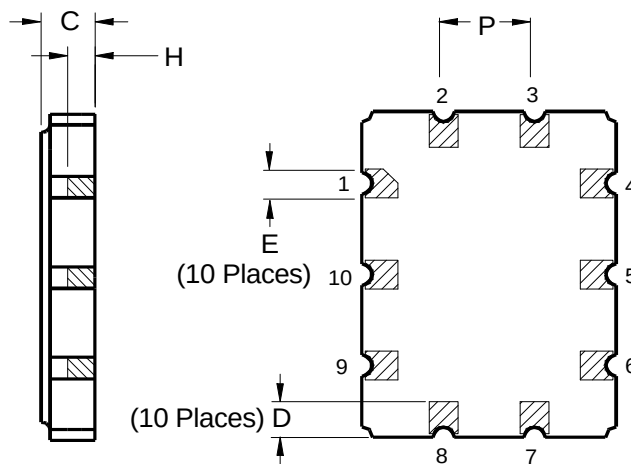
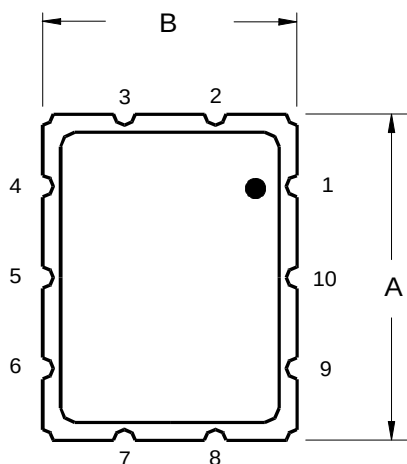
10-Terminal Ceramic Surface-Mount Case
9.1 x 7.1 mm Nominal Footprint

**Case Dimensions**

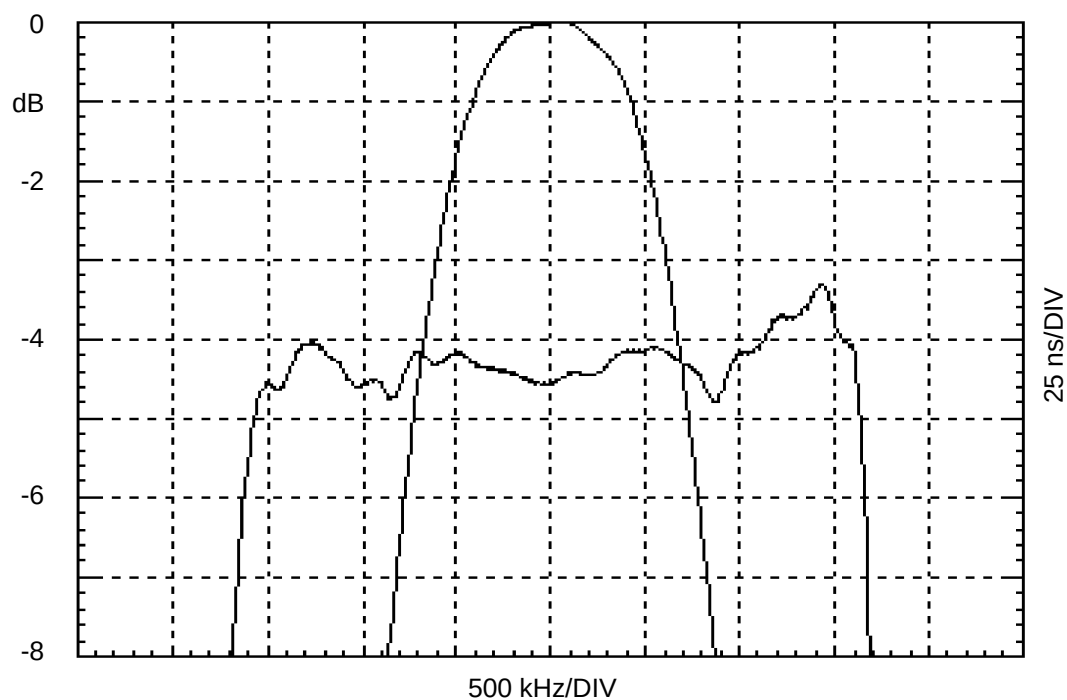
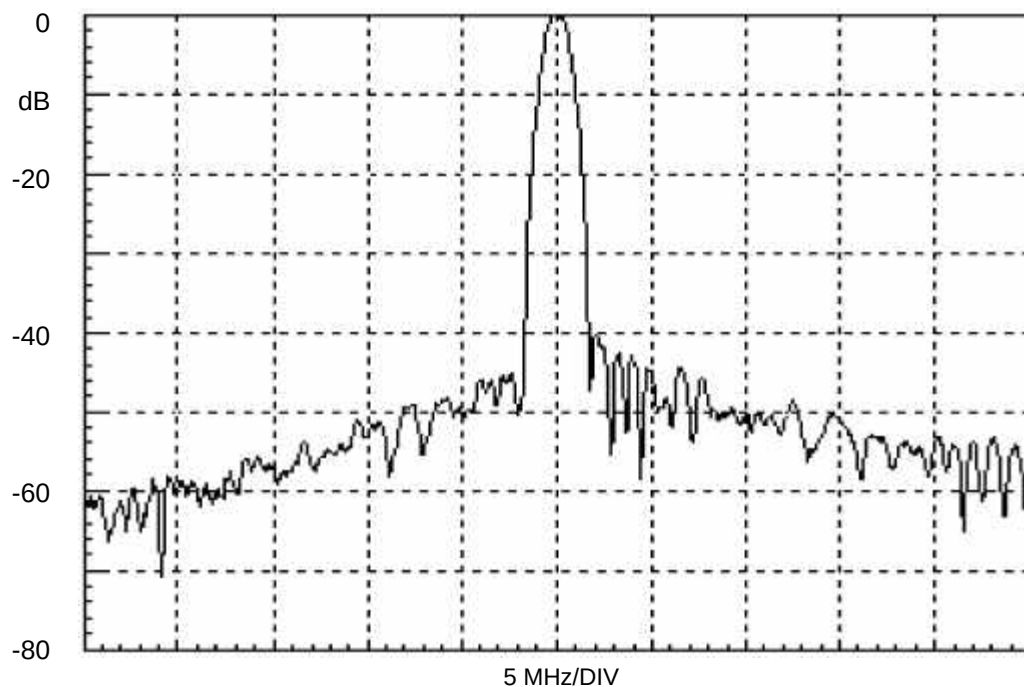
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	8.86	9.09	9.40	0.349	0.358	0.370
B	6.88	7.11	7.40	0.271	0.280	0.291
C		1.91	2.00		0.075	0.079
D		0.99			0.039	
E		0.79			0.031	
H		1.0			0.039	
P		2.54			0.100	

Electrical Connections

Connection		Terminals
Port 1	Input or Return	5
	Return or Input	6
Port 2	Output or Return	10
	Return or Output	1
Ground		All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot



SF1059A 350 MHz SAW Filter



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Home page: www.rfm.com

European Sales Office
44 1963 251383
44 1963 251510

REV	ECN NO.	DESCRIPTION	APP/DATE
A	3887	REL TO MFG	FR 6/19/95
B	4631	CHANGE ADJUSTABLE CAPS TO FIXED CAPS	

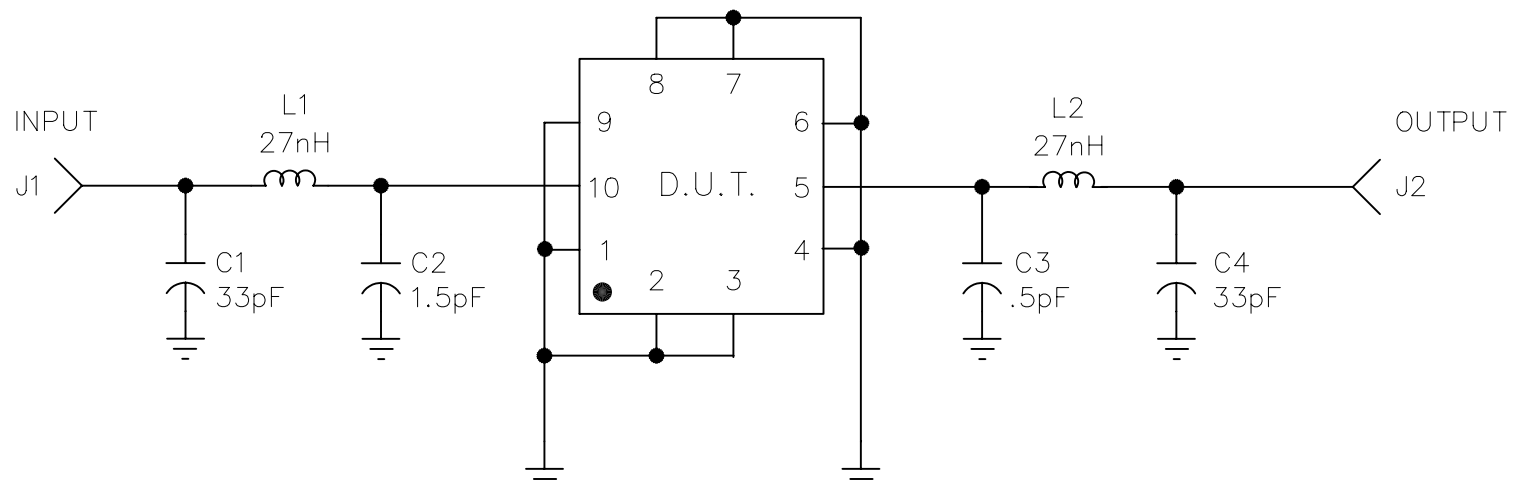
BILL OF MATERIALS

ITEM	QTY	P/N	DESCRIPTION	REF DES	REMARKS
1	1	400-0845-001	PCB	PCB1	
2	1	SF1059A	FILTER	FLTR1	
3	2	500-0003-330	CAP, 33pF	C1,C4	
4	1	500-0003-015	CAP, 1.5pF	C2	
5	1	500-0013-005	CAP, .5pF	C3	
6	2	500-0010-008	CHIP INDUCTOR, 27nH	L1,L2	
7	1	500-0248-001	CONN, COAX, FLANGE MNT	J1,J2	

DRAWN BY/DATE: J.F.Christopherson 25apr95

TITLE: DEMO PCB, SF1059A

RF Monolithics, Inc. DALLAS, TEXAS 75244		SIZE A	CODE IDENT 2U874	DWG. NO. SF1059A(DEMO)	REV B	SHEET 1/6
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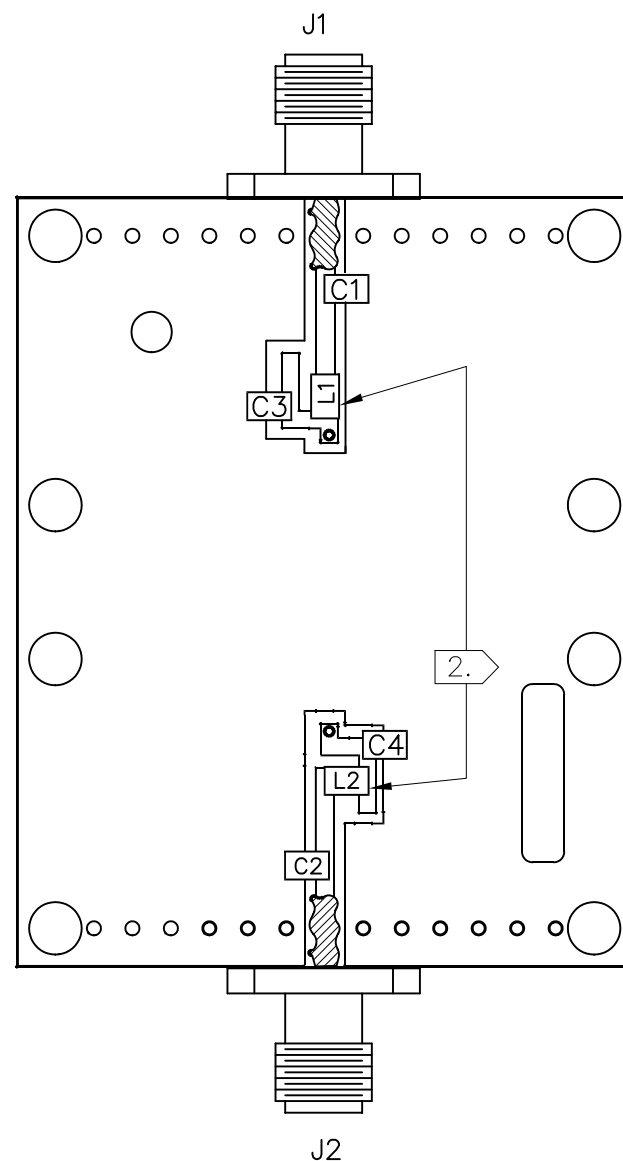
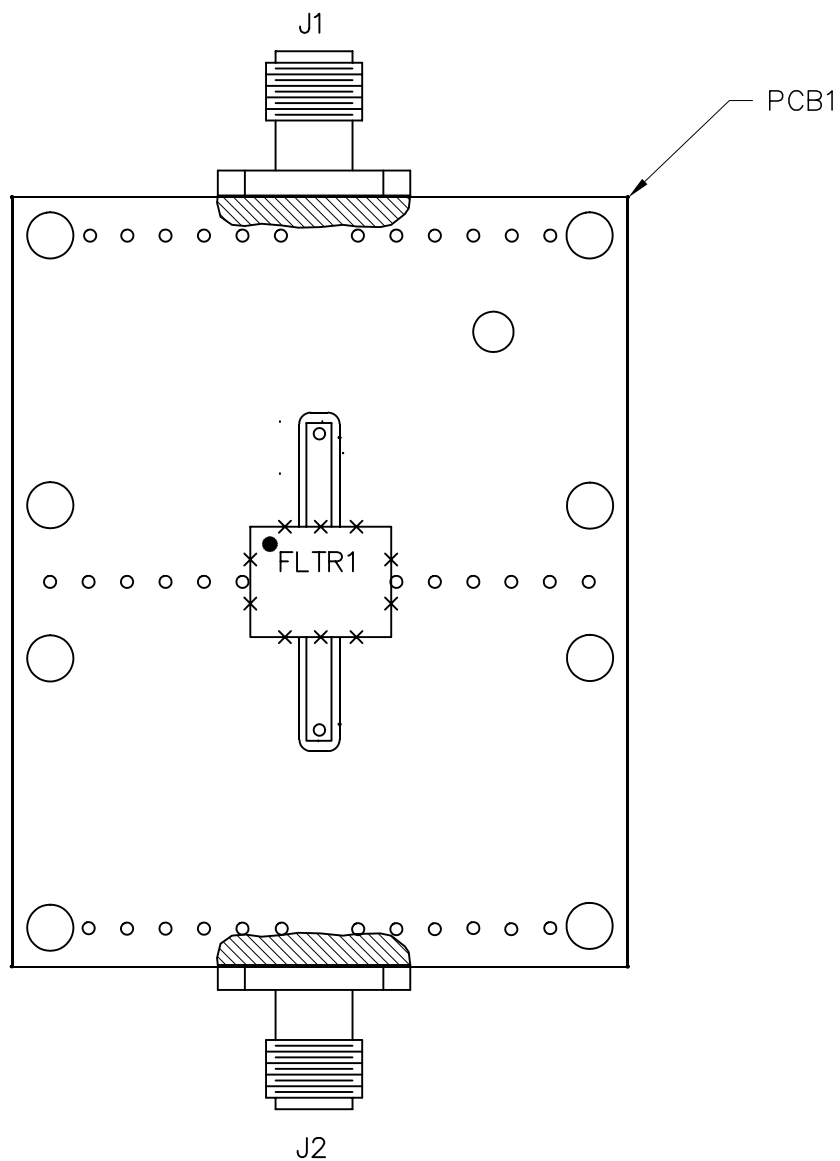


SCHEMATIC

NOTES:

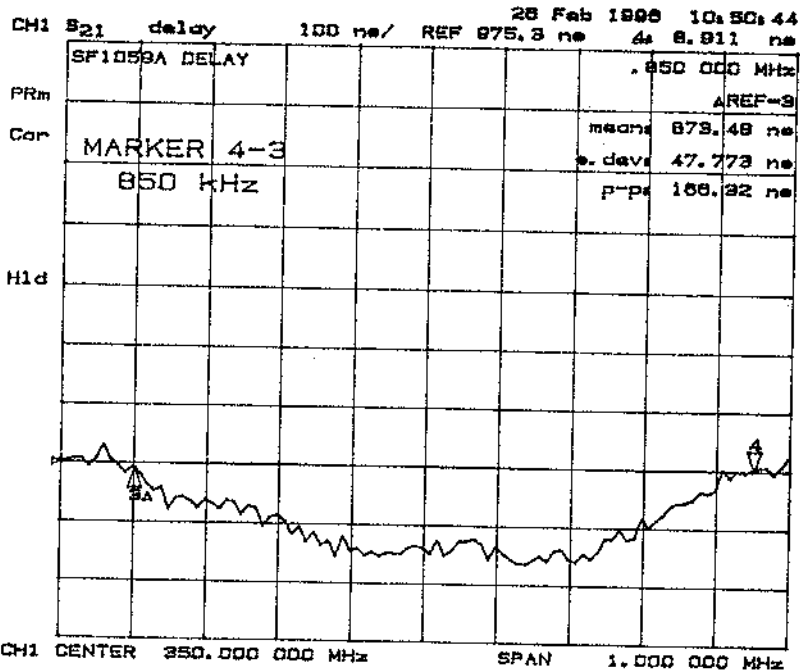
1. SOLDER MOUNT COMPONENTS, CONNECTORS, TO PCB1

2. NOTE PROPER ORIENTATION OF INDUCTORS [L1, L2] SHOULD BE 90° TO EACH OTHER.



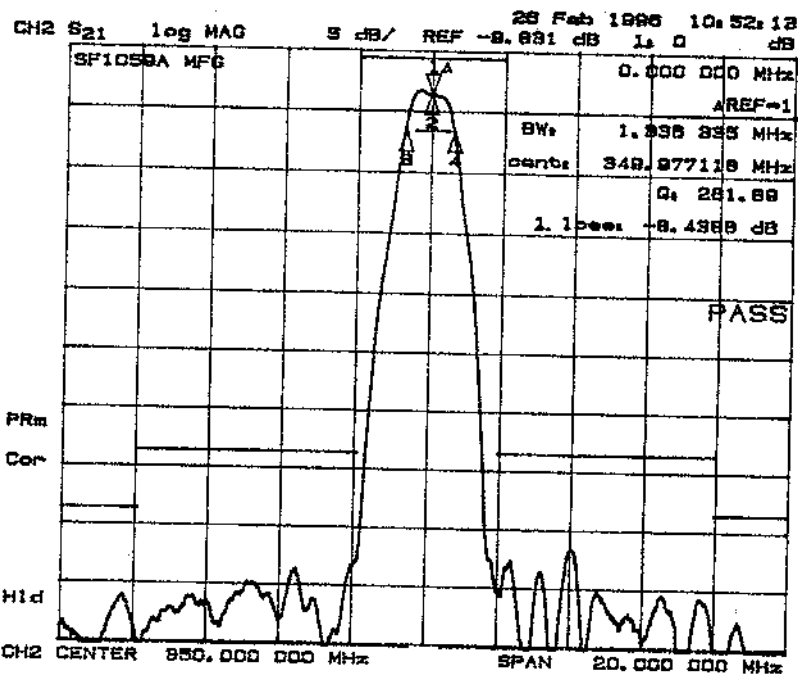
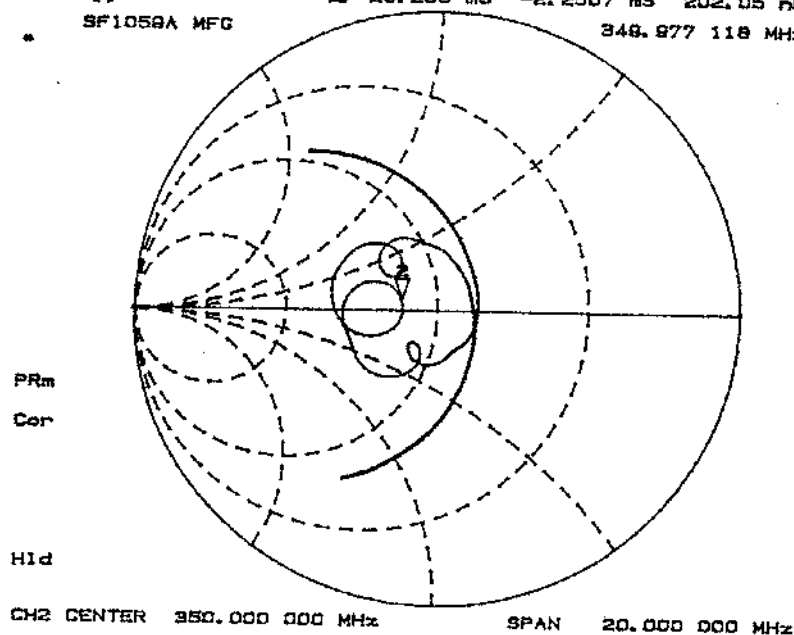
TUNING PROCEDURE:

1. THERE ARE TWO PLOTS INCLUDED IN THIS DOCUMENT.
PLOT #1 SHOWS APPROXIMATE TUNING.
PLOT #2 WILL NEED TO BE GENERATED FOR EACH DEMO. WHEN MORE THAN ONE DEMO IS REQUIRED, DEMO'S NEED TO BE SERIALIZED AND THE SERIALIZATION NOTED ON PLOT #2.
2. DUE TO TOLERANCE VARIATIONS IN THE VALUES OF CAPACITORS AND INDUCTORS, IT MAY BE IMPOSSIBLE TO DUPLICATE TUNING POSITIONS AS DOCUMENTED. IT MAY REQUIRE USING EITHER A SLIGHTLY HIGHER OR SLIGHTLY LOWER VALUE CAPACITOR OR INDUCTOR. THIS WILL DEPEND ON EACH INDEPENDANT PART.



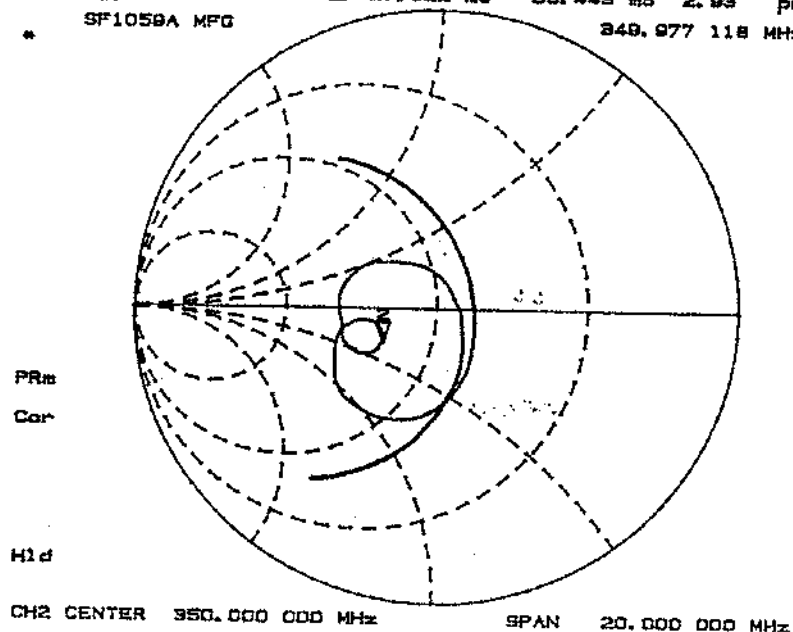
CH2 S11 1 U FS 2 25.295 mS 28 Feb 1998 10:55:08 -2.2507 mS 202.05 nH

SF1059A MFG 349.977 118 MHz



CH2 S22 1 U FS 2 27.822 mS 28 Feb 1998 10:56:57 05.443 mS 2.93 pF

SF1059A MFG 349.977 118 MHz



SF1059A (Demo)

SH. 5 REV: B

SF1059A

Demo

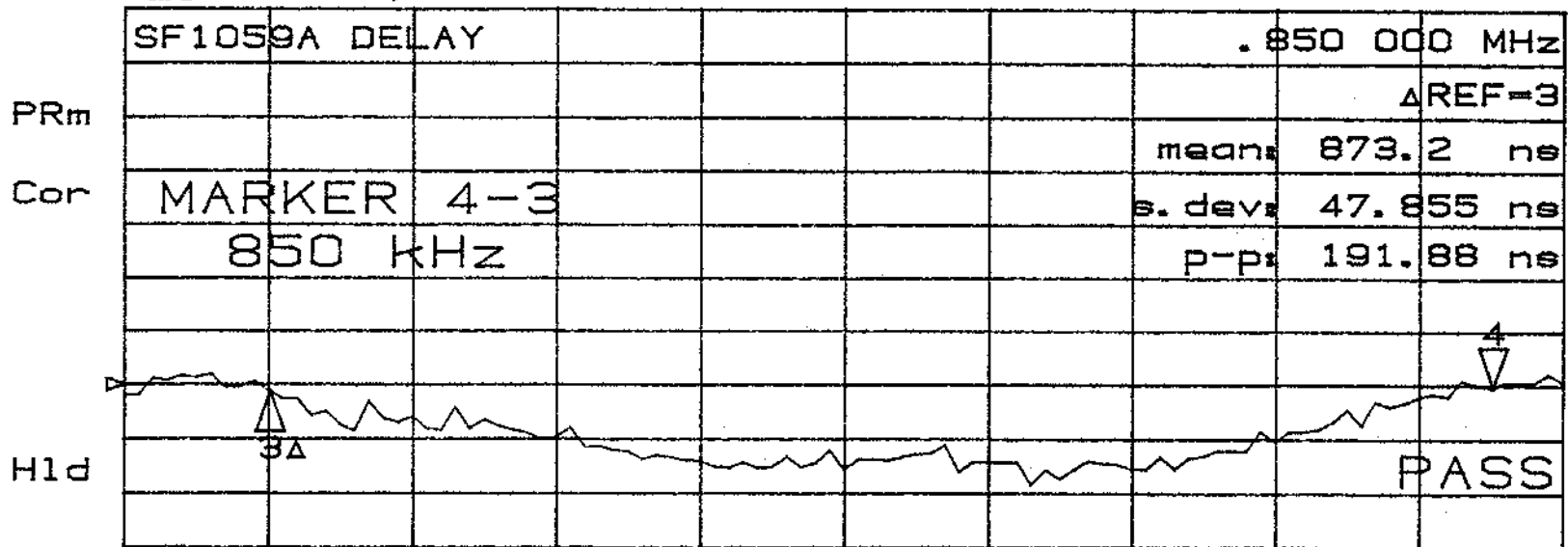
2-26-98

EWB

26 Feb 1996 10:43:56

SF1059A
Demo

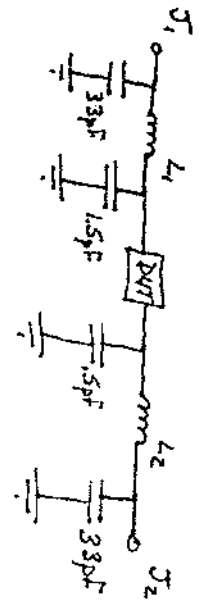
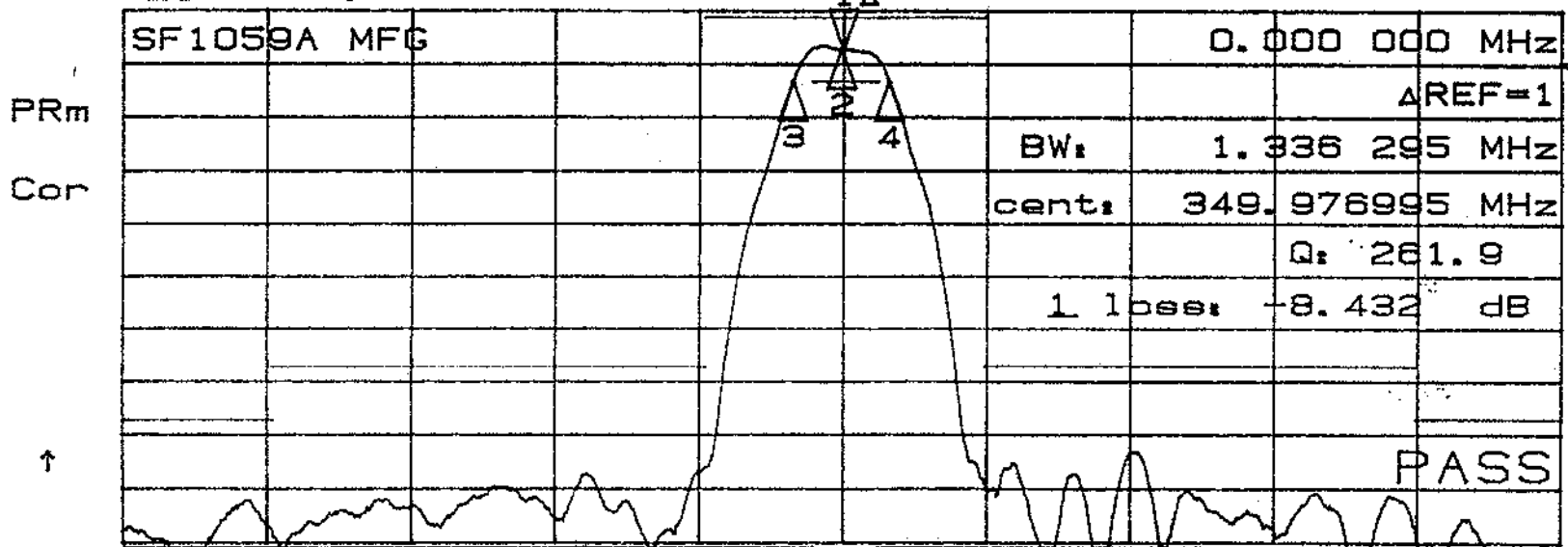
CH1 S₂₁ delay 100 ns/ REF 975.3 ns 4: 9.1552 ns



S₁₁
1.5pF
27nH
33pF
S₂₂
1.5pF
27pF
33pF

2-26-96
[Signature]

CH1 CENTER 350.000 000 MHz SPAN 1.000 000 MHz
CH2 S₂₁ log MAG 5 dB/ REF -9.831 dB 1 0 dB



CH2 CENTER 350.000 000 MHz SPAN 20.000 000 MHz

SF1059A (Demo)
SH. 6 Rev: B